

LM94

TruTherm™ Hardware Monitor with PI Loop Fan Control for Server Management

1.0 General Description

The LM94 hardware monitor has a two wire digital interface compatible with SMBus 2.0. Using a $\Sigma\Delta$ ADC, the LM94 measures the temperature of four remote diode connected transistors as well as its own die and 16 power supply voltages. The LM94 has new TruTherm technology that supports precision thermal diode measurements of processors on sub-micron processes.

To set fan speed, the LM94 has two PWM outputs that are each controlled by up to six temperature zones. The fancontrol algorithm can be based on a lookup table, PI (proportional/integral) control loop, or a combination of both. The LM94 includes digital filters that can be invoked to smooth temperature readings for better control of fan speed such that acoustical noise is minimized. The LM94 has four tachometer inputs to measure fan speed. Limit and status registers for all measured values are included.

The LM94 builds upon the functionality of previous mother-board server management ASICs, such as the LM93. It also adds measurement and control support for dynamic Vccp monitoring for VRD10/11 and PROCHOT. It is designed to monitor a dual processor Xeon class motherboard with a minimum of external components.

2.0 Features

- 8-bit Σ∆ ADC
- Monitors 16 power supplies
- Monitors 4 remote thermal diodes and 2 LM60
- New TruTherm technology support for precision thermal diode measurements
- Internal ambient temperature sensing
- Programmable autonomous fan control based on temperature readings with fan boost support
- Fan boost support on tachometer limit error event
- Fan control based on 13-step lookup table or PI Control Loop or combination of both
- PI fan control loop supports Tcontrol
- Temperature reading digital filters
- 0.5°C digital temperature sensor resolution
- 0.0625°C filtered temperature resolution for fan control

- 2 PWM fan speed control outputs
- 4 fan tachometer inputs
- Dual processor thermal throttling (PROCHOT) monitoring
- Dual dynamic VID monitoring (6/7 VIDs per processor) supports VRD10.2/11
- 8 general purpose I/Os:
 - 4 can be configured as fan tachometer inputs
 - 2 can be configured to connect to processor THERMTRIP
- 2 general purpose inputs that can be used to monitor the 7th VID signal for VRD11
- Limit register comparisons of all monitored values
- 2-wire serial digital interface, SMBus 2.0 compliant
 - Supports byte/block read and write
 - Selectable slave address (tri-level pin selects 1 of 3 possible addresses)
 - ALERT output supports interrupt or comparator modes
- 2.5V reference voltage output
- 56-pin TSSOP package
- XOR-tree test mode

3.0 Key Specifications

voltage Measurement Accuracy	±2% F3 (IIIax
Temperature Resolution	9-bits, 0.5°C
Temperature Sensor Accuracy	±2.5 °C (max
Temperature Range:	
— LM94 Operational	0°C to +85°C
— Remote Temp Accuracy	0°C to +125°C
Power Supply Voltage	+3.0V to +3.6\
Power Supply Current	1.6 mA

4.0 Applications

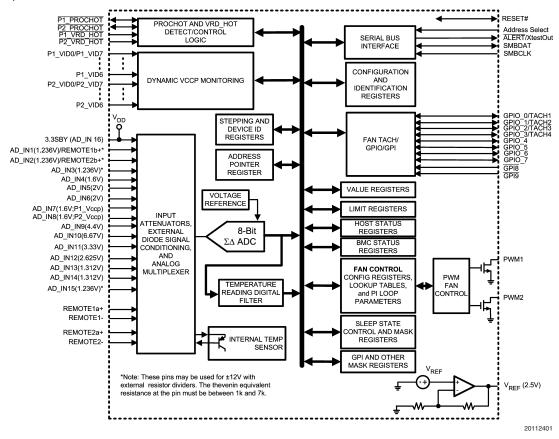
- Servers
- Workstations
- Multi-processor based equipment

5.0 Ordering Information

Order Number NS Package Number		Transport media
LM94CIMT	MTD56	34 units in rail
LM94CIMTX	MTD56	1000 units in tape-and-reel

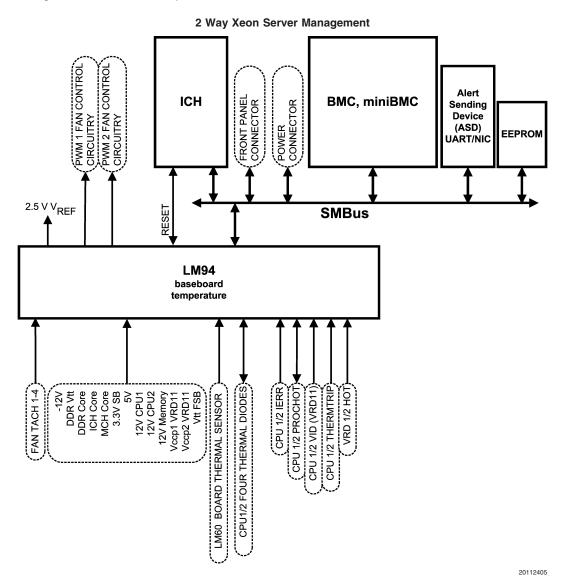
I²C is a registered trademark of the Philips Corporation.

6.0 Block Diagram The block diagram of LM94 hardware is illustrated below. The hardware implementation is a single chip ASIC solution.

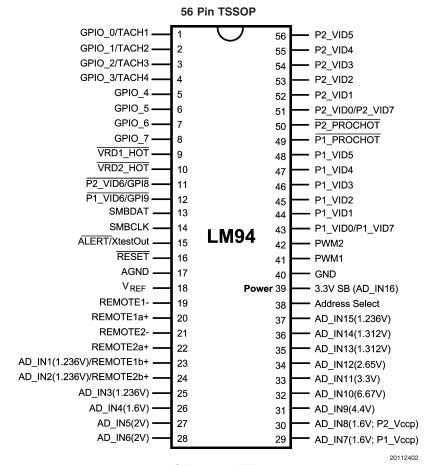


7.0 Application

Baseboard management of a dual processor server. Two LM94s may be required to manage a quad processor board. The system diagram below shows a dual processor server



8.0 Connection Diagram



NS Package MTD56
Top View
NS Order Numbers:
LM94CIMT (34 units per rail), or
LM94CIMTX (1000 units per tape-and-reel)

9.0 Pin Descriptions

Symbol	Pin #	Туре	Function
GPIO_0/TACH1	1	Digital I/O	Can be configured as fan tach input or a general purpose
		(Open-Drain)	open-drain digital I/O.
GPIO_1/TACH2	2	Digital I/O	Can be configured as fan tach input or a general purpose
		(Open-Drain)	open-drain digital I/O.
GPIO_2/TACH3	3	Digital I/O	Can be configured as fan tach input or a general purpose
oo_=,oo		(Open-Drain)	open-drain digital I/O.
GPIO_3/TACH4	4	Digital I/O	Can be configured as fan tach input or a general purpose
ar 10_0/1/10114	-	(Open-Drain)	open-drain digital I/O
GPIO_4 /	5	Digital I/O	A general purpose open-drain digital I/O. Can be configured to
P1_THERMTRIP	5	"	monitor a CPU's THERMTRIP signal to mask other errors. Supports
FI_INENWITHIP		(Open-Drain)	,,
00:0 - /	-	5	TTL input logic levels and AGTL compatible input logic levels.
GPIO_5 /	6	Digital I/O	A general purpose open-drain digital I/O. Can be configured to
P2_THERMTRIP		(Open-Drain)	monitor a CPU's THERMTRIP signal to mask other errors. Supports
			TTL input logic levels and AGTL compatible input logic levels.
GPIO_6	7	Digital I/O	Can be used to detect the state of CPU1 IERR or a general purpose
		(Open-Drain)	open-drain digital I/O. Supports TTL input logic levels and AGTL
			compatible input logic levels.
GPIO_7	8	Digital I/O	Can be used to detect the state of CPU2 IERR or a general purpose
		(Open-Drain)	open-drain digital I/O. Supports TTL input logic levels and AGTL
			compatible input logic levels.
VRD1_HOT	9	Digital Input	CPU1 voltage regulator HOT. Supports TTL input logic levels and
_			AGTL compatible input logic levels.
VRD2_HOT	10	Digital Input	CPU2 voltage regulator HOT. Supports TTL input logic levels and
***************************************	.0	Digital Input	AGTL compatible input logic levels.
P2_VID6/GPI8	11	Digital Input	CPU2 VID6 input. Could also be used as a general purpose input to
1 2_V1D0/Q1 10	' '	Digital Input	trigger an error event. Supports TTL input logic levels and AGTL
			compatible input logic levels.
D4_VIDO/ODIO	10	District Issued	
P1_VID6/GPI9	12	Digital Input	CPU1 VID6 input. Could also be used as a general purpose input to
			trigger an error event. Supports TTL input logic levels and AGTL
			compatible input logic levels.
SMBDAT	13	Digital I/O	Bidirectional System Management Bus Data. Output configured as
		(Open-Drain)	5V tolerant open-drain. SMBus 2.0 compliant.
SMBCLK	14	Digital Input	System Management Bus Clock. Driven by an open-drain output,
			and is 5V tolerant. SMBus 2.0 Compliant.
ALERT/XtestOut	15	Digital Output	Open-drain ALERT output used in an interrupt driven system to
		(Open-Drain)	signal that an error event has occurred. Masked error events do not
			activate the ALERT output. When in XOR tree test mode, functions
			as XOR Tree output.
RESET	16	Digital I/O	Open-drain reset output when power is first applied to the LM94.
		(Open-Drain)	Used as a reset for devices powered by 3.3V stand-by. After reset,
		, ,	this pin becomes a reset input. If this pin is not used, connection to
			an external resistive pull-up is required to prevent LM94 malfunction.
AGND	17	GROUND Input	Analog Ground. Digital ground and analog ground need to be tied
	''	an to orto input	together at the chip then both taken to a low noise system ground.
			A voltage difference between analog and digital ground may cause
\/	46	1	erroneous results.
V_{REF}	18	Analog Output	2.5V used for external ADC reference, or as a V _{REF} reference
			voltage

9.0 Pin Descriptions (Continued)

Symbol	Pin #	Туре	Function
REMOTE1-	19	Remote Thermal Diode_1- Input (CPU 1 THERMDC)	This is the negative input (current sink) from both of the CPU1 thermal diodes. Connected to THERMDC pin of Pentium processor or the emitter of a diode connected MMBT3904 NPN transistor. Serves as the negative input into the A/D for thermal diode voltage measurements. A 100 pF capacitor is optional and can be connected between REMOTE1- and REMOTE1+.
REMOTE1a+	20	Remote Thermal Diode_1+ I/O (CPU1 THERMDA1)	This is a positive connection to the first CPU1 thermal diode. Serves as the positive input into the A/D for thermal diode voltage measurements. It also serves as a current source output that forward biases the thermal diode. Connected to THERMDA pin of Pentium processor or the base of a diode connected MMBT3904 NPN transistor. A 100 pF capacitor is optional and can be connected between REMOTE1– and each REMOTE1+.
REMOTE2-	21	Remote Thermal Diode_2 - Input (CPU2 THERMDC)	This is the negative input (current sink) from both of the CPU2 thermal diodes. Connected to THERMDC pins of Pentium processor or the emitter of a diode connected MMBT3904 NPN transistor. Serves as the negative input into the A/D for thermal diode voltage measurements. A 100 pF capacitor is optional and can be connected between REMOTE2– and each REMOTE2+.
REMOTE2a+	22	Remote Thermal Diode_2 + I/O (CPU2 THERMDA1)	This is a positive connection to the first CPU2 thermal diode. Serves as the positive input into the A/D for thermal diode voltage measurements. It also serves as a current source output that forward biases the thermal diode. Connected to THERMDA pin of Pentium processor or the base of a diode connected MMBT3904 NPN transistor. A 100 pF capacitor is optional and can be connected between REMOTE2- and REMOTE2+.
AD_IN1/REMOTE1b+	23	Analog Input (+12V1 or CPU1 THERMDA2)	Analog Input for +12V Rail 1 monitoring, for CPU1 voltage regulator. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal 3/4 scale reading. This pin may also serve as the second positive thermal diode input for CPU1.
AD_IN2/REMOTE2b+	24	Analog Input (+12V2 or CPU2 THERMDA2)	Analog Input for +12V Rail 2 monitoring, for CPU2 voltage regulator. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal 3/4 scale reading. This pin may also serve as the second positive thermal diode input for CPU2.
AD_IN3	25	Analog Input (+12V3)	Analog Input for +12V Rail 3, for Memory/3GIO slots. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal 3/4 scale reading.
AD_IN4	26	Analog Input (FSB_Vtt)	Analog input for 1.2V monitoring, nominal ¾ scale reading
AD_IN5	27	Analog Input (3GIO / PXH / MCH_Core)	Analog input for 1.5V monitoring, nominal ¾ scale reading
AD_IN6	28	Analog Input (ICH_Core)	Analog input for 1.5V monitoring, nominal ¾ scale reading
AD_IN7 (P1_Vccp)	29	Analog Input (CPU1_Vccp)	Analog input for +Vccp (processor voltage) monitoring.
AD_IN8 (P2_Vccp)	30	Analog Input (CPU2_Vccp)	Analog input for +Vccp (processor voltage) monitoring.
AD_IN9	31	Analog Input (+3.3V)	Analog input for +3.3V monitoring, nominal ¾ scale reading
AD_IN10	32	Analog Input (+5V)	Analog input for +5V monitoring silver box supply monitoring, nominal 34 scale reading

9.0 Pin Descriptions (Continued)

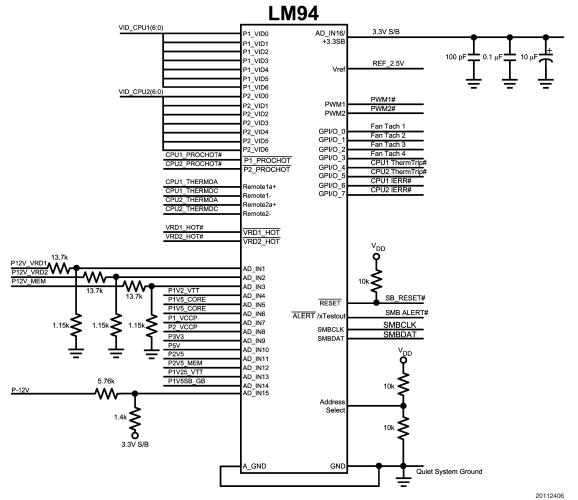
Symbol	Pin #	Туре	Function
AD_IN11	33	Analog Input (SCSI_Core)	Analog input for +2.5V monitoring, nominal 3/4 scale reading. This pin may also be used to monitor an analog temperature sensor such as the LM60, since readings from this input can be routed to the fan control logic.
AD_IN12	34	Analog Input (Mem_Core)	Analog input for +1.969V monitoring, nominal ¾ scale reading.
AD_IN13	35	Analog Input (Mem_Vtt)	Analog input for +0.984V monitoring, nominal 3/4 scale reading.
AD_IN14	36	Analog Input (Gbit_Core)	Analog input for +0.984V S/B monitoring, nominal 3/4 scale reading.
AD_IN15	37	Analog Input (-12V)	Analog input for -12V monitoring. External resistors required to scale to positive level. Full scale reading at 1.236V, , nominal ¾ scale reading. This pin may also be used to monitor an analog temperature sensor such as the LM60, since readings from this input can be routed to the fan control logic.
Address Select	38	3 level analog input	This input selects the lower two bits of the LM94 SMBus slave address.
3.3V SB (AD_IN16)	39	POWER (V _{DD}) +3.3V standby power	V_{DD} power input for LM94. Generally this is connected to +3.3V standby power. The LM94 can be powered by +3.3V if monitoring in low power states is not required, but power should be applied to this input before any other pins. This pin also serves as the analog input to monitor the 3.3V stand-by (SB) voltage. It is necessary to bypass this pin with a 0.1 μF in parallel with 100 pF. A bulk capacitance of 10 μF should be in the near vicinity. The 100 pF should be closest to the power pin.
GND	40	GROUND	Digital Ground. Digital ground and analog ground need to be tied together at the chip then both taken to a low noise system ground. A voltage difference between analog and digital ground may cause erroneous results.
PWM1	41	Digital Output (Open-Drain)	Fan control output 1.
PWM2	42	Digital Output (Open-Drain)	Fan control output 2
P1_VID0/P1_VID7	43	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID1	44	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID2	45	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID3	46	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID4	47	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID5	48	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_PROCHOT	49	Digital I/O (Open-Drain)	Connected to CPU1 PROCHOT (processor hot) signal through a bidirectional level shifter. Supports TTL input logic levels and AGTL compatible input logic levels.
P2_PROCHOT	50	Digital I/O (Open-Drain)	Connected to CPU2 PROCHOT (processor hot) signal through a bidirectional level shifter. Supports TTL input logic levels and AGTL compatible input logic levels.

9.0 Pin Descriptions (Continued)

Symbol	Pin #	Туре	Function
P2_VID0/P2_VID7	51	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.
P2_VID1	52	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.
P2_VID2	53	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.
P2_VID3	54	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.
P2_VID4	55	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.
P2_VID5	56	Digital Input	Voltage Identification signal from the processor. Supports TTL input
			logic levels and AGTL compatible input logic levels.

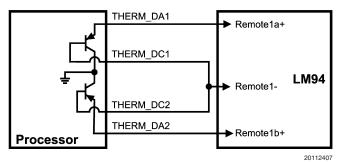
The over-score indicates the signal is active low ("Not").

10.0 Recommended Implementation



Recommended implementation without thermal diode connections

10.0 Recommended Implementation (Continued)



Note: 100 pF cap across each thermal diode is optional and should be placed close to the LM94, if used. The maximum capacitance between thermal diode pins is 300 pF.

Thermal diode recommended implementation

11.0 Functional Description

The LM94 provides 16 channels of voltage monitoring, 4 remote thermal diode monitors, an internal/local ambient temperature sensor, 2 PROCHOT monitors, 4 fan tachometers, 8 GPIOs, THERMTRIP monitor for masking error events, 2 sets of 7 VID inputs, an ALERT output and all the associated limit registers on a single chip, and communicates to the rest of the baseboard over the System Management Bus (SMBus). The LM94 also provides 2 PWM outputs and associated fan control logic for controlling the speed of system fans. There are two sets of fan control logic, a lookup table and a PI (proportional/integral) loop controller. The lookup table and PI controller are interactive, such that the fans run at the fastest required speed. Upon a temperature or fan tach error event, the PWM outputs may be programmed such that they automatically boost to 100% duty cycle. A timer is included that sets the minimum time that the fans are in the boost condition when activated by a fan tach

The LM94 incorporates National Semiconductor's TruTherm technology for precision "Remote Diode" readings of processors on 90nm process geometry or smaller. Readings from the external thermal diodes and the internal temperature sensor are made available as an 9-bit two's-complement digital value with the LSb representing 0.5°C. Filtered temperature readings are available as a 12-bit two's-complement digital value with the LSb representing 0.0625°C.

All but 4 of the analog inputs include internal scaling resistors. External scaling resistors are required for measuring $\pm 12 V$. The inputs are converted to 8-bit digital values such that a nominal voltage appears at $^{3}\!\!/_{\!4}$ scale for positive voltages and $^{1}\!\!/_{\!4}$ scale for negative voltages. The analog inputs are intended to be connected to both baseboard resident VRDs and to standard voltage rails supplied by a SSI compliant power supply.

The LM94 has logic that ties a set of dynamically moving VID inputs to their associated Vccp analog input for real time window comparison fault determination. Voltage mapping for VRD10, VRD10 extended and VRD11are supported by the LM94. When VRD10 mode is selected GPI8 and GPI9 can be used to detect external error flags whose state is be reflected in the status registers.

Error events are captured in two sets of mirrored status registers (BMC Error Status Registers and Host Status Registers) allowing two controllers access to the status information without any interference.

The LM94's ALERT output supports interrupt mode or comparator mode of operation. The comparator mode is only functional for thermal monitoring.

The LM94 provides a number of internal registers, which are detailed in the register section of this document.

12.0 Please contact your local sales office for complete LM94 applications information.

13.0 Registers

13.1 REGISTER WARNINGS

In most cases, reserved registers and register bits return zero when read. This should not be relied upon, since reserved registers can be used for future expansion of the LM94 functions.

Some registers have "N/D" for their default value. This means that the power-up default of the register is not defined. In the case of value registers, care should be taken to ensure that software does not read a value register until the associated measurement function has acquired a measurement. This applies to temperatures, voltages, fan RPM, and PROCHOT monitoring.

13.2 REGISTER SUMMARY TABLE

Register Key

Term	Description	
N/D	Not Defined	
N/A	Not Applicable	
R	Read Only	
R/W	Read or Write	
RWC	Read or Write to Clear	

Lock	Register Name	Address	Description
FACT	ORY REGISTERS		
Х	XOR Test	00h	Used to set the XOR test tree mode
	SMBus Test	01h	SMBus read/write test register
	Reserved	02h-04h	
"REM	OTE DIODE" MODE SELECT		
Х	Transistor Mode Select	05h	Selects Diode Mode (default) or Transistor Mode for "Remote Diode" measurements
VALU	E REGISTER SECTION 1	•	
	Zone 1b (CPU1 Diode b) Temp	06h	Measured value of remote thermal diode temperature channel 1b
	Zone 2b (CPU2 Diode b) Temp	07h	Measured value of remote thermal diode temperature channel 2b
	Zone 1b (CPU1 Diode b) Filtered Temp	08h	Filtered value of remote thermal diode temperature channel 1b
	Zone 2b (CPU2 Diode b) Fitlered Temp	09h	Filtered value of remote thermal diode temperature channel 2
	PWM1 8-bit Duty Cycle Value	0Ah	8- bit value of the PWM1 duty cycle.
	PWM2 8-bit Duty Cycle Value	0Bh	8-bit value of the PWM2 duty cycle
HIGH	RESOLUTION PWM OVERIDE REGIST	TERS	
х	PWM1 Duty Cycle Override (low byte)	0Ch	Lower byte of the high resolution PWM1 duty cycle register
Х	PWM1 Duty Cycle Override (high byte)	0Dh	Upper byte of the high resolution PWM1 duty cycle register
Х	PWM2 Duty Cycle Override (low byte)	0Eh	Lower byte of the high resolution PWM2 duty cycle register
Х	PWM2 Duty Cycle Override (high byte)	0Fh	Upper byte of the high resolution PWM2 duty cycle register
EXTE	NDED RESOLUTION TEMPERATURE	VALUE REGIS	TERS
	Z1a_LSB	10h	Zone 1a (CPU1) extended resolution unfiltered temperature value register, least-significant byte
	Z1a_MSB	11h	Zone 1a (CPU1) extended resolution unfiltered temperature value register, most-significant byte
	Z1b_LSB	12h	Zone 1b (CPU1) extended resolution unfiltered temperature value register, least-significant-byte
	Z1b_MSB	13h	Zone 1b (CPU1) extended resolution unfiltered temperature value register, most-significant byte
	Z2a_LSB	14h	Zone 2a (CPU2) extended resolution unfiltered temperature value register, least-significant-byte
	Z2a_MSB	15h	Zone 2a (CPU2) extended resolution unfiltered temperature value register, most-significant byte

Lock	Register Name	Address	Description
EXTE	NDED RESOLUTION TEMPERATURE	VALUE REGIS	TERS
	Z2b_LSB	16h	Zone 2b (CPU2) extended resolution unfiltered temperature
			value register, least-significant-byte
	Z2b_MSB	17h	Zone 2b (CPU2) extended resolution unfiltered temperature
			value register, most-significant byte
	Z1a_F_LSB	18h	Zone 1a (CPU1) extended resolution filtered temperature value
			register, least-significant byte
	Z1a_F_MSB	19h	Zone 1a (CPU1) extended resolution filtered temperature value
			register, most-significant byte
	Z1b_F_LSB	1Ah	Zone 1b (CPU1) extended resolution filtered temperature value
			register, least-significant-byte
	Z1b_F_MSB	1Bh	Zone 1b (CPU1) extended resolution filtered temperature value
			register, most-significant byte
	Z2a_F_LSB	1Ch	Zone 2a (CPU2) extended resolution filtered temperature value
			register, least-significant-byte
	Z2a_F_MSB	1Dh	Zone 2a (CPU2) extended resolution filtered temperature value
			register, most-significant byte
	Z2b_F_LSB	1Eh	Zone 2b (CPU2) extended resolution filtered temperature value
			register, least-significant-byte
	Z2b_F_MSB	1Fh	Zone 2b (CPU2) extended resolution filtered temperature value
			register, most-significant byte
	Z3_LSB	20h	Zone 3 (Internal) extended resolution temperature value
			register, least-significant byte
	Z3_MSB	21h	Zone 3 (Internal) extended resolution temperature value
			register, least-significant byte
	Z4_LSB	22h	Zone 4 (External Digital) extended resolution temperature value
			register, most-significant byte
	Z4_MSB	23h	Zone 4 (External Digital) extended resolution temperature value
			register, least-significant byte
	Reserved	24h-30h	
I LO	OP AND FAN CONTROL SETUP REGI	STERS	
	Temperature Source Select	31h	Selects the temperature source for some temperature zones.
	PWM Filter Settings	32h	Sets the IIR filter coefficients for the PWM outputs for low
			resolution sources
	PWM1 Filter Shutoff Threshold	33h	PWM1 Filter Shutoff Threshold
	PWM2 Filter Shutoff Threshold	34h	PWM2 Filter Shutoff Threshold
	PI/LUT Fan Control Bindings	35h	PI/LUT fan control binding configuration
	PI Controller Minimum PWM and	36h	PI Controller Minimum PWM and Hysteresis settings
	Hysteresis		
	Zone 1 Tcontrol	37h	Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol)
	Zone 2 Tcontrol	38h	Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol)
	Zone 1 Toff	39h	Zone 1 (CPU1) PI Controller Off Temperature (Toff)
	Zone 2 Toff	3Ah	Zone 2 (CPU2) PI Controller Off Temperature (Toff)
	P Coefficient	3Bh	PI controller proportional coefficient
	I Coefficient	3Ch	PI controller integral coefficient
	PI Exponents	3Dh	PI controller coefficient exponents
	Exponente	JUII	1.1 Softional accimatorit experients
	E IDENTIFICATION REGISTERS		

Lock Register Name	Address	Description
PI LOOP AND FAN CONTROL SETUP REGIS	TERS	
Version/Stepping	3Fh	Contains code for major and minor revisions
BMC ERROR STATUS REGISTERS		
B_Error Status 1	40h	BMC error status register 1
B_Error Status 2	41h	BMC error register 2
B_Error Status 3	42h	BMC error register 3
B_Error Status 4	43h	BMC error register 4
B_P1_PROCHOT Error Status	44h	BMC error register for P1_PROCHOT
B_P2_PROCHOT Error Status	45h	BMC error register for P2_PROCHOT
B_GPI Error Status	46h	BMC error register for GPIs
B_Fan Error Status	47h	BMC error register for Fans
HOST ERROR STATUS REGISTERS		
H_Error Status 1	48h	HOST error status register 1
H_Error Status 2	49h	HOST error register 2
H_Error Status 3	4Ah	HOST error register 3
H_Error Status 4	4Bh	HOST error register 4
H_P1_PROCHOT Error Status	4Ch	HOST error register for P1_PROCHOT
H_P2_PROCHOT Error Status	4Dh	HOST error register for P2_PROCHOT
H_GPI Error Status	4Eh	HOST error register for GPIs
H_Fan Error Status	4Fh	HOST error register for Fans
VALUE REGISTERS SECTION 2		
Zone 1a (CPU1) Temp	50h	Measured value of remote thermal diode temperature channel 1a
Zone 2a (CPU2) Temp	51h	Measured value of remote thermal diode temperature channel 2a
Zone 3 (Internal) Temp	52h	Measured temperature from on-chip sensor
Zone 4 (External Digital) Temp	53h	Measured temperature from external temperature sensor
Zone 1a (CPU1) Filtered Temp	54h	Filtered value of remote thermal diode temperature channel 1a
Zone 2a (CPU2) Filtered Temp	55h	Filtered value of remote thermal diode temperature channel 2a
AD_IN1 Voltage	56h	Measured value of AD_IN1
AD_IN2 Voltage	57h	Measured value of AD_IN2
AD_IN3 Voltage	58h	Measured value of AD_IN3
AD_IN4 Voltage	59h	Measured value of AD_IN4
AD_IN5 Voltage	5Ah	Measured value of AD_IN5
AD_IN6 Voltage	5Bh	Measured value of AD_IN6
AD_IN7 Voltage	5Ch	Measured value of AD_IN7
AD_IN8 Voltage	5Dh	Measured value of AD_IN8
AD_IN9 Voltage	5Eh	Measured value of AD_IN9
AD_IN10 Voltage	5Fh	Measured value of AD_IN10
AD_IN11 Voltage	60h	Measured value of AD_IN11
AD_IN12 Voltage	61h	Measured value of AD_IN12
AD_IN13 Voltage	62h	Measured value of AD_IN13
AD_IN14 Voltage	63h	Measured value of AD_IN14
AD_IN15 Voltage	64h	Measured value of AD_IN15
AD_IN16 Voltage	65h	Measured value of AD_IN16 (V _{DD} 3.3V S/B)
Reserved	66h	
Current P1_PDCCUCT	675	Macaused D1 DDOCHOT threshly never the
Current P1_PROCHOT	67h	Measured P1_PROCHOT throttle percentage

Lock	Register Name	Address	Description
VALUE	E REGISTERS SECTION 2		
	Average P1_PROCHOT	68h	Average P1_PROCHOT throttle percentage
	Current P2_PROCHOT	69h	Measured P2_PROCHOT throttle percentage
	Average P2_PROCHOT	6Ah	Average P2_PROCHOT throttle percentage
	GPI State	6Bh	Current GPIO state
	P1_VID	6Ch	Current VID value of Processor 1
	P2_VID	6Dh	Current VID value of Processor 2
	FAN Tach 1 LSB	6Eh	Measured FAN Tach 1 LSB
	FAN Tach 1 MSB	6Fh	Measured FAN Tach 1 MSB
		-	
	FAN Tach 2 LSB	70h	Measured FAN Tach 2 LSB
	FAN Tach 2 MSB	71h	Measured FAN Tach 2 MSB
	FAN Tach 3 LSB	72h	Measured FAN Tach 3 LSB
	FAN Tach 3 MSB	73h	Measured FAN Tach 3 MSB
	FAN Tach 4 LSB	74h	Measured FAN Tach 4 LSB
	FAN Tach 4 MSB	75h	Measured FAN Tach 4 MSB
	Reserved	76h-77h	
EMP	ERATURE LIMIT REGISTERS		
	Zone 1 (CPU1) Low Temp	78h	Low limit for external thermal diode temperature channel 1 (D1 measurement
	Zone 1 (CPU1) High Temp	79h	High limit for external thermal diode temperature channel 1 (D1) measurement
	Zone 2 (CPU2) Low Temp	7Ah	Low limit for external thermal diode temperature channel 2 (D2 measurement
	Zone 2 (CPU2) High Temp	7Bh	High limit for external thermal diode temperature channel 2 (D2) measurement
	Zone 3 (Internal) Low Temp	7Ch	Low limit for local temperature measurement
	Zone 3 (Internal) High Temp	7Dh	High limit for local temperature measurement
	Zone 4 (External Digital) Low Temp	7Eh	Low limit for external digital temperature sensor
	Zone 4 (External Digital) High Temp	7Fh	High limit for external digital temperature sensor
		201	7 (00)
	Fan Boost Temp Zone 1	80h	Zone 1 (CPU1) fan boost temperature
	Fan Boost Temp Zone 2	81h	Zone 2 (CPU2) fan boost temperature
	Fan Boost Temp Zone 3	82h	Zone 3 (Internal) fan boost temperature
	Fan Boost Temp Zone 4	83h	Zone 4 (External Digital) fan boost temperature
	Zone1 and Zone 2 Hysteresis	84h	Zone 1 and Zone 2 hysteresis for limit comparisons
	Zone 3 and Zone 4 Hysteresis	85h	Zone 3 and Zone 4 hysteresis for limit comparisons
	Reserved	86h-8Dh	
'ON-	4b and 0b TEMPERATURE REARING	AD IIIOTAE	T DECICTEDS
ONE	1b and 2b TEMPERATURE READING		
	Zone 1b Temp Adjust	8Eh	Allows all Zone 1b temperature measurements to be adjusted by a programmable offset.
1	1	1	2) a programmatio ontota
	Zone 2b Temp Adjust	8Fh	Allows all Zone 2b temperature measurements to be adjusted

Lock	Register Name	Address	Description
THE	R LIMIT REGISTERS	·	
	AD_IN1 Low Limit	90h	Low limit for analog input 1 measurement
	AD_IN1 High Limit	91h	High limit for analog input 1 measurement
	AD_IN2 Low Limit	92h	Low limit for analog input 2 measurement
	AD_IN2 High Limit	93h	High limit for analog input 2 measurement
	AD_IN3 Low Limit	94h	Low limit for analog input 3 measurement
	AD_IN3 High Limit	95h	High limit for analog input 3 measurement
	AD_IN4 Low Limit	96h	Low limit for analog input 4 measurement
	AD_IN4 High Limit	97h	High limit for analog input 4 measurement
	AD_IN5 Low Limit	98h	Low limit for analog input 5 measurement
	AD_IN5 High Limit	99h	High limit for analog input 5 measurement
	AD_IN6 Low Limit	9Ah	Low limit for analog input 6 measurement
	AD_IN6 High Limit	9Bh	High limit for analog input 6 measurement
	AD_IN7 Low Limit	9Ch	Low limit for analog input 7 measurement
	AD_IN7 High Limit	9Dh	High limit for analog input 7 measurement
	AD_IN8 Low Limit	9Eh	Low limit for analog input 8 measurement
	AD_IN8 High Limit	9Fh	High limit for analog input 8 measurement
	AD_IN9 Low Limit	A0h	Low limit for analog input 9 measurement
	AD_IN9 High Limit	A1h	High limit for analog input 9 measurement
	AD_IN10 Low Limit	A2h	Low limit for analog input 10 measurement
	AD_IN10 High Limit	A3h	High limit for analog input 10 measurement
	AD_IN11 Low Limit	A4h	Low limit for analog input 11 measurement
	AD_IN11 High Limit	A5h	High limit for analog input 11 measurement
	AD_IN12 Low Limit	A6h	Low limit for analog input 12 measurement
	AD_IN12 High Limit	A7h	High limit for analog input 12 measurement
	AD_IN13 Low Limit	A8h	Low limit for analog input 13 measurement
	AD_IN13 High Limit	A9h	High limit for analog input 13 measurement
	AD_IN14 Low Limit	AAh	Low limit for analog input 14 measurement
	AD_IN14 High Limit	ABh	High limit for analog input 14 measurement
	AD_IN15 Low Limit	ACh	Low limit for analog input 15 measurement
	AD_IN15 High Limit	ADh	High limit for analog input 15 measurement
	AD_IN16 Low Limit	AEh	Low limit for analog input 16 measurement
	AD_IN16 High Limit	AFh	High limit for analog input 16 measurement
	AD_INTO HIGH LIMIN	AIII	riigh innicion analog input to measurement
-	P1_PROCHOT User Limit	B0h	User settable limit for P1_PROCHOT
	P2_PROCHOT User Limit	B1h	User settable limit for P2_PROCHOT
-	FZ_FNOCHOT Osei Liiliit	Bill	Oser settable little for F2_FNOCHOT
	Vccp1 Limit Offsets	B2h	VID offset values for window comparator for CPU1 Vccp
	VCCP1 Limit Onsets	DZII	(AD_IN7)
	Vccp2 Limit Offsets	B3h	VID offset values for window comparator for CPU2 Vccp
	Voop2 Emili Onocio	2011	(AD_IN8)
			(**=_*****)
	FAN Tach 1 Limit LSB	B4h	FAN Tach 1 Limit LSB
-	FAN Tach 1 Limit MSB	B5h	FAN Tach 1 Limit MSB
	FAN Tach 2 Limit LSB	B6h	FAN Tach 2 Limit LSB
	FAN Tach 2 Limit MSB	B7h	FAN Tach 2 Limit MSB
	FAN Tach 3 Limit LSB	B8h	FAN Tach 3 Limit LSB
	FAN Tach 3 Limit MSB	B9h	FAN Tach 3 Limit MSB
	. , v . aoi. o Ellilli WOD	5011	1744 TOOL O EMILE MOD

Lock	Register Name	Address	Description		
OTHE	R LIMIT REGISTERS				
	FAN Tach 4 Limit MSB	BBh	FAN Tach 4 Limit MSB		
SETU	PREGISTERS				
	Special Function Control 1	BCh	Controls the hysteresis for voltage limit comparisons. Also selects filtered or unfiltered temperature usage for temperature limit comparisons and fan control.		
	Special Function Control 2	BDh	Enables smart tach detection. Also selects 0.5°C or 1.0°C resolution for fan control.		
х	GPI / VID Level Control	BEh	Control the input threshold levels for the P1_VIDx, P2_VIDx and GPIO_x inputs.		
Х	PWM Ramp Control	BFh	Controls the ramp rate of the PWM duty cycle when VRDx_HOT is asserted, as well as the ramp rate when PROCHOT exceeds the user threshold.		
Х	Fan Boost Hysteresis (Zones 1/2)	C0h	Fan Boost Hysteresis for zones 1 and 2		
х	Fan Boost Hysteresis (Zones 3/4)	C1h	Fan Boost Hysteresis for zones 3 and 4		
X	Zones 1/2 Spike Smoothing Control	C2h	Configures Spike Smoothing for zones 1 and 2		
Х	LUT 1/2 MinPWM and Hysteresis	C3h	Controls MinPWM and hysteresis setting for LUT 1 and 2 auto-fan control		
х	LUT 3/4 MinPWM and Hysteresis	C4h	Controls MinPWM and hysteresis setting for LUT 3 and 4 auto-fan control		
	GPO	C5h	Controls the output state of the GPIO pins		
	PROCHOT Control	C6h	Controls assertion of P1_PROCHOT or P2_PROCHOT		
	PROCHOT Time Interval	C7h	Configures the time window over which the PROCHOT inputs are measured		
Х	PWM1 Control 1	C8h	Controls PWM control source bindings.		
Х	PWM1 Control 2	C9h	Controls PWM override and output polarity		
Х	PWM1 Control 3	CAh	Controls PWM spin-up duration and duty cycle		
Х	PWM1 Control 4	CBh	Frequency control for PWM1.		
Х	PWM2 Control 1	CCh	Controls PWM control source bindings.		
Х	PWM2 Control 2	CDh	Controls PWM override and output polarity		
Х	PWM2 Control 3	CEh	Controls PWM spin-up duration and duty cycle		
Х	PWM2 Control 4	CFh	Frequency control for PWM2		
х	LUT 1 Base Temperature	D0h	Base temperature to which look-up table offset is applied for LUT 1		
х	LUT 2 Base Temperature	D1h	Base temperature to which look-up table offset is applied for LUT 2		
Х	LUT 3 Base Temperature	D2h	Base temperature to which look-up table offset is applied for LUT 3		
х	LUT 4 Base Temperature	D3h	Base temperature to which look-up table offset is applied for LUT 4		
Х	Step 2 Temp Offset	D4h	Step 2 LUT 1/2 and LUT 3/4 Offset Temperatures		
Х	Step 3 Temp Offset	D5h	Step 3 LUT 1/2 and LUT 3/4 Offset Temperatures		
х	Step 4 Temp Offset	D6h	Step 4 LUT 1/2 and LUT 3/4 Offset Temperatures		
х	Step 5 Temp Offset	D7h	Step 5 LUT 1/2 and LUT 3/4 Offset Temperatures		

Lock		Address	Description
SETU	P REGISTERS		
Х	Step 6 Temp Offset	D8h	Step 6 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 7 Temp Offset	D9h	Step 7 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 8 Temp Offset	DAh	Step 8 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 9 Temp Offset	DBh	Step 9 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 10 Temp Offset	DCh	Step 10 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 11 Temp Offset	DDh	Step 11 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 12 Temp Offset	DEh	Step 12 LUT 1/2 and LUT 3/4 Offset Temperatures
Х	Step 13 Temp Offset	DFh	Step 13 LUT 1/2 and LUT 3/4 Offset Temperatures
	TACH to PWM Binding	E0h	Controls the tachometer input to PWM output binding
Х	Tach Boost Control	E1h	Controls the fan boost function upon a tach error
		1	·
Х	LM94 Status/Control	E2h	Gives Master error status, ASF reset control and Max PWM
			control
X	LM94 Configuration	E3h	Configures various outputs and provides START bit
SLEE	P STATE CONTROL AND MASK REG	ISTERS	
	Sleep State Control	E4h	Used to communicate the system sleep state to the LM94
	S1 GPI Mask	E5h	Sleep state S1 GPI error mask register
	S1 Fan Mask	E6h	Sleep state S1 fan tach error mask register
	S3 GPI Mask	E7h	Sleep state S3 GPI error mask register
	S3 Fan Mask	E8h	Sleep state S3 fan tach error mask register
	S3 Temperature/Voltage Mask	E9h	Sleep state S3 temperature or voltage error mask register
	S4/5 GPI Mask	EAh	Sleep state S4/5 GPI error mask register
OTUE	S4/5 Temperature/Voltage Mask	EBh	Sleep state S4/5 temperature or voltage error mask register
OTHE	ER MASK REGISTERS		
	GPI Error Mask	ECh	Error mask register for GPI faults
	Miscellaneous Error Mask	EDh	Error mask register for VRDx_HOT, GPI, and dynamic Vccp
			limit checking.
7011	A. AND OF TEMPERATURE READIN	0.40	IT DECICIEDO
ZONE	1a AND 2a TEMPERATURE READIN	G ADJUSTNEN	II REGISTERS
	Zone 1a Temp Adjust	EEh	Allows all Zone 1a temperature measurements to be adjusted
	, ,		by a programmable offset
	Zone 1a Temp Adjust Zone 2a Temp Adjust	EEh EFh	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted
BI OC	Zone 2a Temp Adjust		by a programmable offset
BLOC	Zone 2a Temp Adjust	EFh	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset
BLOC	Zone 2a Temp Adjust CK COMMANDS Block Write Command	EFh F0h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code
BLOC	Zone 2a Temp Adjust CK COMMANDS Block Write Command Block Read Command	F0h F1h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call
BLOC	Zone 2a Temp Adjust CK COMMANDS Block Write Command Block Read Command Fixed Block 0	F0h F1h F2h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes
BLOO	Zone 2a Temp Adjust CK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1	F0h F1h F2h F3h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2	F0h F1h F2h F3h F4h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3	F0h F1h F2h F3h F4h F5h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes
BLOC	Zone 2a Temp Adjust CK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3 Fixed Block 4	F0h F1h F2h F3h F4h F5h F6h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3	F0h F1h F2h F3h F4h F5h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes
BLOC	Zone 2a Temp Adjust CK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3 Fixed Block 4	F0h F1h F2h F3h F4h F5h F6h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes Fixed block code address 67h, size 4 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3 Fixed Block 4 Fixed Block 5	F0h F1h F2h F3h F4h F5h F6h F7h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes Fixed block code address 67h, size 4 bytes Fixed block code address 66h, size 8 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3 Fixed Block 4 Fixed Block 5 Fixed Block 6	F0h F1h F2h F3h F4h F5h F6h F7h F8h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 48h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes Fixed block code address 67h, size 4 bytes Fixed block code address 66h, size 8 bytes Fixed block code address 78h, size 12 bytes
BLOC	Zone 2a Temp Adjust EK COMMANDS Block Write Command Block Read Command Fixed Block 0 Fixed Block 1 Fixed Block 2 Fixed Block 3 Fixed Block 4 Fixed Block 5 Fixed Block 6 Fixed Block 7	F0h F1h F2h F3h F4h F5h F6h F7h F8h F9h	by a programmable offset Allows all Zone 2a temperature measurements to be adjusted by a programmable offset SMBus Block Write Command Code SMBus Block Write/Read Process call Fixed block code address 40h, size 8 bytes Fixed block code address 50h, size 8 bytes Fixed block code address 50h, size 6 bytes Fixed block code address 56h, size 16 bytes Fixed block code address 67h, size 4 bytes Fixed block code address 6Eh, size 8 bytes Fixed block code address 78h, size 12 bytes Fixed block code address 90h, size 32 bytes

Lock	Register Name	Address	Description		
BLOC	K COMMANDS				
	Fixed Block 11	FDh	Fixed block code address E5h, size 9 bytes		
	Reserved		Reserved for future commands		

Please contact your local sales office for complete LM94 applications information.

14.0 Absolute Maximum

Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Positive Supply Voltage (V_{DD}) 6.0V Voltage on Any Digital Input or -0.3V to 6.0V Output Pin (Except Analog Inputs)

Voltage on +5V Input -0.3V to +6.667V

Voltage at Positive Remote
Diode Inputs, AD_IN1, AD_IN2,

AD_IN3, and AD_IN15 Inputs -0.3V to $(V_{DD} + 0.05V)$

Voltage at Other Analog Voltage

Inputs -0.3V to +6.0V

Input Current at Thermal Diode

Negative Inputs ±1 mA

Input Current at any pin (Note 3) ±10mA
Package Input Current (Note 3) ±100 mA

Maximum Junction Temperature

(Note 9)

 (T_{JMAX}) 150 °C

ESD Susceptibility (Note 4)

Human Body Model 3 kV

Machine Model 300V

Charged Device Model 750V

Storage Temperature -65°C to +150°C

Soldering process must comply with National's reflow temperature profile specifications. Refer to www.national.com/packaging/. (Note 5)

15.0 Operating Ratings (Notes 1, 2)

 $T_{\text{MIN}} \leq T_{\text{A}} \leq T_{\text{MAX}}$ Operating Temperature Range $0^{\circ}\text{C} \leq T_{\text{A}} \leq +85^{\circ}\text{C}$ Nominal Supply Voltage 3.3V Supply Voltage Range $(V_{\text{DD}}) +3.0\text{V to } +3.6\text{V}$ VID0-VID5 -0.05V to +5.5V Digital Input Voltage Range -0.05V to +5.5V Package Thermal Resistance $(V_{\text{DD}} + 0.05\text{V})$

(Note 6)

DC Electrical Characteristics

The following limits apply for +3.0 V_{DC} to +3.6 V_{DC} , unless otherwise noted. **Bold face limits apply for T_A = T_J over T_{MIN} to T_{MAX} of the operating range;** all other limits T_A = T_J = 25°C unless otherwise noted. T_A is the ambient temperature of the LM94; T_J is the junction temperature of the LM94; T_D is the junction temperature of the thermal diode.

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 10)	Units (Limits)
POWER SUF	PPLY CHARACTERISTICS				•
	Power Supply Current	Converting, Interface and			
		Fans Inactive, Peak	2	2.75	mA (max
		Current			
		Converting, Interface and			
		Fans Inactive, Average	1.6		mA
		Current			
	Power-On Reset Threshold Voltage		0	1.6	V (min)
			2	2.7	V (max)
ΓEMPERATU	JRE-TO-DIGITAL CONVERTER CHARACTERISTICS	S	•	1	l
	Local Temperature Accuracy Over Full Range	$0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq 85^{\circ}\text{C}$	±2	±3	°C (max
		T _A = +55°C	±1	±2.5	°C (max
	Local Temperature Resolution		1		°C
	Remote Thermal Diode Temperature Accuracy	$0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq 85^{\circ}\text{C}$			°0 /
	Over Full Range; targeted for a typical Pentium	and $0^{\circ}C \le T_D \le 100^{\circ}C$		±3	°C (max
	processor on 90 nm or 65 nm process(Note 8)	$0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq 85^{\circ}\text{C}$.0.5	°0 /
		and T _D =70°C		±2.5	°C (max
	Remote Thermal Diode Temperature Accuracy;	$0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq 85^{\circ}\text{C}$			
	targeted for a typical Pentium processor on 90nm	and $25^{\circ}\text{C} \le \text{T}_{\text{D}} \le 70^{\circ}\text{C}$	±1		°C
	or 65nm process (Note 8)				
	Remote Temperature Resolution		1		°C
	Thermal Diode Source Current	High Level	172	230	μA (max
		Low Level	10.75		μA
	Thermal Diode Current Ratio		16		
Γ _C	Total Monitoring Cycle Time			100	ms (max

DC Electrical Characteristics (Continued)

The following limits apply for +3.0 V_{DC} to +3.6 V_{DC} , unless otherwise noted. **Bold face limits apply for T_A = T_J over T_{MIN} to T_{MAX} of the operating range;** all other limits T_A = T_J = 25°C unless otherwise noted. T_A is the ambient temperature of the LM94; T_J is the junction temperature of the LM94; T_D is the junction temperature of the thermal diode.

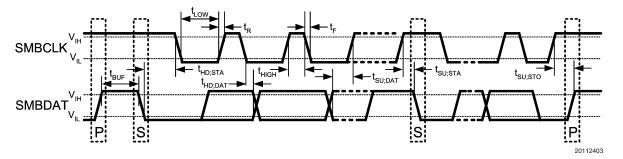
Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 10)	Units (Limits)
ANAI OG-T	│ O-DIGITAL VOLTAGE MEASUREMENT CONVERTEI	CHARACTERISTICS	(Note 9)	(Note 10)	(Lillins)
TUE	Total Unadjusted Error (Note 12)				% of
.02	Total Olladjactod Ellot (1966-12)			±2	FS (max)
DNL	Differential Non-Linearity		±1		LSB
PSS	Power Supply (V _{DD}) Sensitivity				%/V (of
	11 3 (55)		±1		FS)
T _C	Total Monitoring Cycle Time			100	ms (max)
-	Input Resistance for Inputs with Dividers		200	140	kΩ (min)
	AD_IN1- AD_IN3 and AD_IN15 Analog Input			00	- A ()
	Leakage Current (Note 13)			60	nA (max)
REFERENC	E OUTPUT (V _{REF}) CHARACTERISTICS			•	
	Tolerance			±1	% (max)
V _{REF}	Output Voltage (Note 14)		2.500	2.525	V (max)
			2.500	2.475	V (min)
	Load Regulation	I _{SOURCE} = -2 mA	0.1		%
		I _{SINK} = 2 mA	0.1		70
DIGITAL O	JTPUTS: PWM1, PWM2				
I _{OL}	Maximum Current Sink			8	mA (min)
V _{OL}	Output Low Voltage	I _{OUT} = 8.0 mA		0.4	V (max)
	JTPUTS: ALL				
V_{OL}	Output Low Voltage (Note excessive current flow	$I_{OUT} = 4.0 \text{ mA}$		0.4	V (min)
	causes self-heating and degrades the internal	I _{OUT} = 6 mA		0.55	V (min)
	temperature accuracy.)				` ′
I _{OH}	High Level Output Leakage Current	$V_{OUT} = V_{DD}$	0.1	10	μA (max)
I _{OTMAX}	Maximum Total Sink Current for all Digital Outputs			32	mA (max)
	Combined				
Co	Digital Output Capacitance		20		pF
DIGITAL IN					
V _{IH}	Input High Voltage Except Address Select			2.1	V (min)
V _{IL}	Input Low Voltage Except Address Select			0.8	V (max)
V _{IH}	Input High Voltage for Address Select			90% V _{DD}	V (min)
V_{IM}	Input Mid Voltage for Address Select			43% V _{DD}	V (min)
M	Innuit Law Valtage for Address Calast			57% V _{DD}	V (max)
V _{IL}	Input Low Voltage for Address Select		0.2	10% V _{DD}	V (max)
V _{HYST}	DC Hysteresis	V - V	0.3	10	V (min)
I _{IH}	Input High Current Input Low Current	$V_{IN} = V_{DD}$		-10 10	μA (min)
I _{IL}	•	V _{IN} = 0V	00	10	μA (max)
C _{IN}	Digital Input Capacitance	DIO 6 ODIO 5 ODIO 4 (I	20	liva la!4	pF
	PUTS: P1_VIDx, P2_VIDx, GPI_9, GPI_8, GPIO_7, G Eh GPI/VID Level Control)	PIO_6, GPIO_5, GPIO_4 (V	vnen respec	tive bit set	ın
V _{IH}	Alternate Input High Voltage (AGTL+ Compatible)			0.8	V (min)

AC Electrical Characteristics

The following limits apply for +3.0 V_{DC} to +3.6 V_{DC} , unless otherwise noted. **Bold face limits apply for T_A = T_J = T_{MIN} to T_{MAX} of the operating range;** all other limits T_A = T_J = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 10)	Units (Limits)
FAN RPM-TO	O-DIGITAL CHARACTERISTICS				
	Counter Resolution		14		bits
	Number of fan tach pulses count is		2		pulses
	based on				
	Counter Frequency		22.5		kHz
	Accuracy			±6	% (max
PWM OUTPU	JT CHARACTERISTICS		•	'	
	Frequency Tolerances			±6	% (max
	Duty-Cycle Tolerance		±2	±6	% (max
RESET INPU	IT/OUTPUT CHARACTERISTICS		1		
	Output Pulse Width			250	ms (mir
	Upon Power Up			330	ms (ma
	Minimum Input Pulse Width			10	μs (min
	Reset Output Fall Time	1.6V to 0.4V Logic Levels		1	μs (max
SMBus TIMI	NG CHARACTERISTICS		'		
f _{SMBCLK}	SMBCLK (Clock) Clock Frequency			10	kHz (mi
OMBOLIK				100	kHz (ma
t _{BUF}	SMBus Free Time between Stop and			4.7	, .
	Start Conditions			4.7	μs (min
t _{HD;STA}	Hold time after (Repeated) Start				
	Condition. After this period, the first			4.0	μs (mir
	clock is generated.				
t _{SU;STA}	Repeated Start Condition Setup Time			4.7	μs (min
t _{su;sto}	Stop Condition Setup Time			4.0	μs (min
t _{SU;DAT}	Data Input Setup Time to SMBCLK			250	ns (min
	High			250	115 (111111
t _{HD;DAT}	Data Output Hold Time after SMBCLK			300	ns (min
	Low			1075	ns (max
t_{LOW}	SMBCLK Low Period			4.7	μs (min
				50	μs (max
t _{HIGH}	SMBCLK High Period			4.0	μs (min
				50	µs (max
t _R	Rise Time			1	μs (max
t _F	Fall Time			300	ns (max
t _{TIMEOUT}	Timeout		31		ms
	SMBDAT or SMBCLK low			25	ms (mir
	time required to			35	ms (ma
	reset the Serial Bus				
	Interface to the Idle State				
t _{POR}	Time in which a device must be	V _{DD} > +2.8V		500	ms (ma
	operational after power-on reset				
C_L	Capacitance Load on SMBCLK and			400	pF (max
	SMBDAT				α

16.0 Timing Waveform



17.0 Electrical Notes

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: All voltages are measured with respect to GND, unless otherwise noted.

Note 3: When the input voltage (V_{IN}) at any pin exceeds the power supplies $(V_{IN} < (GND \text{ or } AGND) \text{ or } V_{IN} > V_{DD}$, except for analog voltage inputs), the current at that pin should be limited to 10 mA. The 100 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to ten. Parasitic components and/or ESD protection circuitry are shown below for the LM94's pins. Care should be taken not to forward bias the parasitic diode, D1, present on pins D+ and D- as shown in circuits C and D. Doing so by more than 50 mV may corrupt temperature measurements. D1 and the ESD Clamp are connected between V+ $(V_{DD}, AD_{-}IN16)$ and GND as shown in circuit B. SNP stands for snap-back device.

Symbol	Pin #	Circuit	All Input Circuits
GPIO_0/TACH1	1	Α	PIN
GPIO_1/TACH2	2	Α	D1
GPIO_2/TACH3	3	Α	SNP
GPIO_3/TACH4	4	Α	<u> </u>
GPIO_4 / P1_THERMTRIP	5	Α	GND
GPIO_5 / P2_THERMTRIP	6	Α	Circuit A
GPIO_6	7	Α	
GPIO_7	8	Α	
VRD1_HOT	9	Α	
VRD2_HOT	10	Α	
SCSI_TERM1	11	Α	
SCSI_TERM2	12	Α	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
SMBDAT	13	Α	
SMBCLK	14	A	D2★ ₹160 k
ALERT/XtestOut	15	A	ESD D1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
RESET	16	A	D3★ \$80 k
AGND	17	B (Internally	<u> </u>
		shorted to	∐ GND
		GND pin.)	Circuit B
V _{REF}	18	Α	
REMOTE1-	19	С	
REMOTE1+	20	D	
REMOTE2-	21	С	
REMOTE+	22	D	

17.0 Electrical Notes (Continued)

Symbol	Pin #	Circuit	All Input Circuits
AD_IN1	23	D	
AD_IN2	24	D	H
AD_IN3	25	D	D2
AD_IN4	26	E] PINT! I
AD_IN5	27	E	D1 6.5V ESD CLAMP
AD_IN6	28	Е	<u> </u>
AD_IN7	29	E	☐GND
AD_IN8	30	E	Circuit C
AD_IN9	31	E	
AD_IN10	32	E	
AD_IN11	33	E	
AD_IN12	34	E	!
AD_IN13	35	E	50Ω
AD_IN14	36	E	PIN PIN
AD_IN15	37	D	SNP TD1
ADDR_SEL	38	Α	<u> </u>
AD_IN16/V _{DD} (V+)	39	В	☐GND Circuit D
GND	40	B (Internally	Circuit D
		shorted to	
		AGND.)	
PWM1	41	A	-
PWM2	42	A	
P1_VID0	43	A	-
P1_VID1	44	A	
P1_VID2	45	A	
P1_VID3	46	A	_ :
P1_VID4	47	A	PIN D
P1_VID5	48	A	SNP ★ D1 R2 ★
P1_PROCHOT	49	A	
P2_PROCHOT	50	A	GND
P2_VID0	51	A	Circuit E
P2_VID1	52	A	
P2_VID2	53	A	
P2_VID3	54	A	
P2_VID4	55	A	
P2_VID5	56	Α	

Note 4: Human body model, 100 pF discharged through a 1.5 k Ω resistor. Machine model, 200 pF discharged directly into each pin. Charged device model (CDM) simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged.

Note 5: Reflow temperature profiles are different for lead-free and non lead-free packages.

Note 6: The maximum power dissipation must be de-rated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} and the ambient temperature, T_A . The maximum allowable power dissipation at any temperature is $P_{D\ MAX} = (T_{JMAX} - T_A) / \theta_{JA}$. The θ_{JA} for the LM94 when mounted to 1 oz. copper foil PCB the θ_{JA} with different air flow is listed in the following table.

Air Flow	Junction to Ambient Thermal Resistance, θ_{JA}
0 m/s	79 °C/W
1.14 m/s (225 LFPM)	62 °C/W
2.54 m/s (500 LFPM)	52 °C/W

Note 7: See the URL "http://www.national.com/packaging/" for other recommendations and methods of soldering surface mount devices.

Note 8: At the time of first pubication of this specification (Jan 2006), this specification applies to either Pentium or Xeon Processors on 90nm or 65nm process when TruTherm is selected. When TruTherm is deselected this specification applies to an MMBT3904. This specification does include the error caused by the variability of the diode ideality and series resistance parameters.

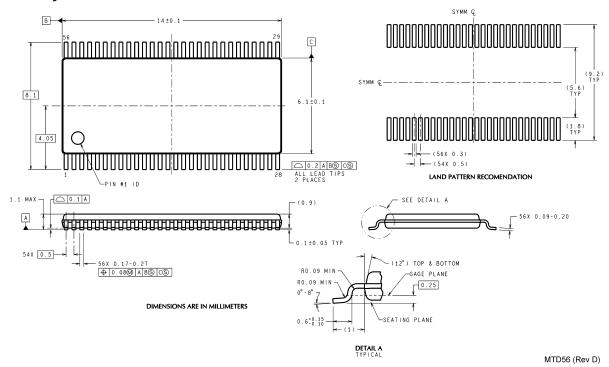
Note 9: Typical parameters are at T_J = T_A = 25 $^{\circ}C$ and represent most likely parametric norm.

17.0 Electrical Notes (Continued)

- Note 10: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).
- Note 11: TUE (Total Unadjusted Error) includes Offset, Gain and Linearity errors of the ADC.
- Note 12: Total Monitoring Cycle Time includes all temperature and voltage conversions.
- Note 13: Leakage current approximately doubles every 20 °C.
- Note 14: A total digital I/O current of 40 mA can cause 6 mV of offset in Vref.
- Note 15: Timing specifications are tested at the TTL logic levels, V_{IL} = 0.4V for a falling edge and V_{IH} = 2.4V for a rising edge. TRI-STATE output voltage is forced

to 1.4V.

18.0 Physical Dimensions inches (millimeters) unless otherwise noted



56-Lead Molded TSSOP Package, JEDEC Registration Number MO-153 Variation EE, Order Number LM94CIMT or LM94CIMTX, NS Package Number MTD56

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